

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Benedikt Specht</td><td>12/16/2007</td></tr><tr><td>Gottfried Ferber</td><td>10/20/2007</td></tr></tbody></table>	Name	Execution Date	Benedikt Specht	12/16/2007	Gottfried Ferber	10/20/2007	
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Benedikt Specht	12/16/2007						
Gottfried Ferber	10/20/2007						
RECEIVING PARTY DATA							
Name:	Infineon Technologies AG						
Street Address:	Am Campeon 1-12						
City:	Neubiberg						
State/Country:	GERMANY						
Postal Code:	85579						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11874550</td></tr></tbody></table>	Property Type	Number	Application Number:	11874550			
Property Type	Number						
Application Number:	11874550						
CORRESPONDENCE DATA							
Fax Number:	(612)573-2005						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	612-767-2502						
Email:	pkempf@dbclaw.com						
Correspondent Name:	Paul P. Kempf						
Address Line 1:	FIFTH STREET TOWERS						
Address Line 2:	100 SOUTH FIFTH STREET, SUITE 2250						
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402						
ATTORNEY DOCKET NUMBER:	I434.164.101/IFT1245US2						
NAME OF SUBMITTER:	Paul P. Kempf						
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PATENT

500432234

REEL: 020318 FRAME: 0962

### ASSIGNMENT

For good and valuable consideration, I, Benedikt Specht, a citizen of Germany, residing at Plettenberger Strasse 5, Sundem, Germany 59846 and Gottfried Ferber, a citizen of Germany, residing at Suermannsholt 3, Warstein, Germany 59581, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, Neubiberg, Germany, 85579, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on October 18, 2007

US. Serial No. 11/874,550,

entitled: **POWER SEMICONDUCTOR MODULE METHOD**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: \_\_\_\_\_

NAME: Benedikt Specht

DATE: \_\_\_\_\_

16.12.07

SIGNATURE: \_\_\_\_\_

NAME: Gottfried Ferber

DATE: \_\_\_\_\_

### ASSIGNMENT

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SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_

NAME: Benedikt Specht

SIGNATURE: Gottfried Ferber DATE: 20. Okt. 2007

NAME: Gottfried Ferber